## 1. Part No. Expression:

# <u>WAEZ46101-RL-10</u>

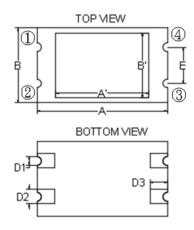
(a) (b) (c) (d) (e)(f) (g)

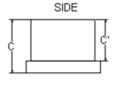
- (a) Series Code
- (b) Dimension Code
- (c) Internal Controlled Number

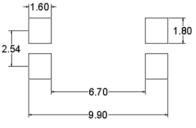
(d) Impedance Code

- (e) Packaging Code (f) Current Code
- (g) Standard Code

## 2. Configuration & Dimensions:





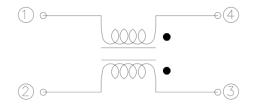


Recommended PCB layout

Unit: mm

Series	А	A'	В	B'	С	C'	D1	D2	D3	E
WAEZ44	9.10±0.2	4.50±0.2	5.17±0.2	3.20±0.2	3.90±0.2	2.80±0.2	0.60±0.1	1.00±0.1	1.20±0.1	2.50±0.2
WAEZ46	9.10±0.2	6.50±0.3	5.17±0.2	4.50±0.2	3.80±0.2	2.70±0.2	0.60±0.1	1.00±0.1	1.20±0.1	2.50±0.2

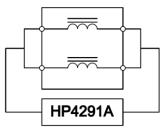
# 3. Schematic:



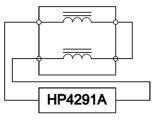
NOTE: Specifications subject to change without notice. Please check our website for latest information.

4. Measuring Circuits:

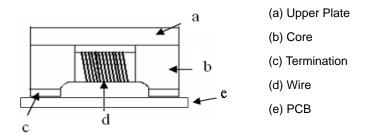
# Common mode



# Differential mode



# 5. Material List:



# 6. General Specification:

(a) Operating Temp. : -25°C to +105°C (Including self - temperature rise).

(b) Storage Temp. : -40°C to +125°C (on board).

(c) Irms. : Based on temperature rise ( $\Delta T$  : 40°C) Max.

(d) Storage Condition (Component in its packaging)

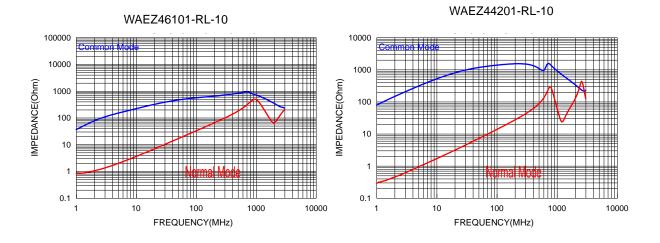
- i) Temperature: Less than 40°C
- ii) Humidity : 60% RH

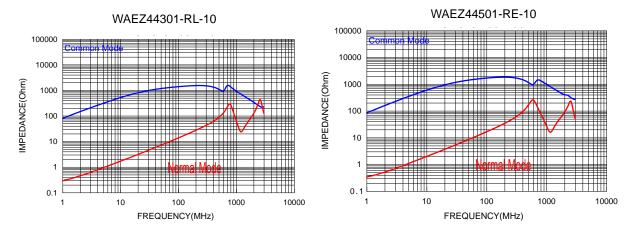
NOTE: Specifications subject to change without notice. Please check our website for latest information.

Part Number	Common Mode Impedance (Ω)		Test Frequency (MHz)	DCR (Ω) Max.	Rated Current (A)	Rated Volt. (Vdc)	Withstand Volt. (Vdc)	IR (MΩ) Min.
	Min.	Тур.			Max.	Max.	Max.	
WAEZ46101-RL-10	100	-	20 to 100	0.10	2.00	50	250	100
WAEZ44201-RL-10	200	-	20 to 300	0.12	2.00	50	125	100
WAEZ44301-RL-10	300	-	6 to 20	0.12	2.00	50	125	100
WAEZ44501-RE-10	500	1000	10	0.15	0.50	80	200	100
WAEZ44102-RE-10	1000	2000	10	0.25	0.50	80	200	100
WAEZ46601-RE-10	600	1000	10	0.25	0.50	80	200	100
WAEZ46102-RE-10	1000	2000	10	0.30	0.50	80	200	100

## 7. Electrical Characteristics:

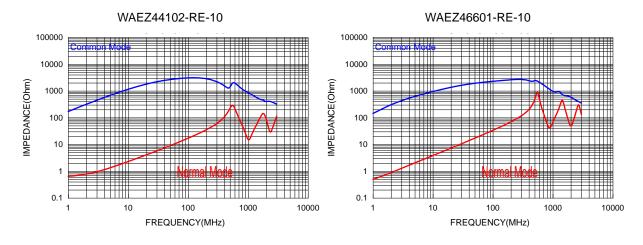
## 8. Characteristics Curves:



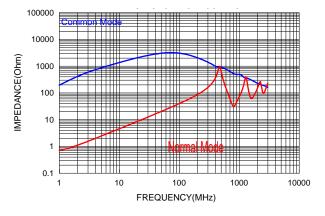


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WAEZ46102-RE-10



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## 9. Soldering:

Mildly activated rosin fluxes are preferred. Our terminations are suitable for all re-flow soldering systems. If hand soldering cannot be avoided, the preferred technique is the utilization of hot air soldering tools.

#### 9-1 Solder Re-flow

Recommended temperature profiles for re-flow soldering in Figure 1.

#### 9-2 Soldering Iron (Figure 2)

Products attachment with soldering iron is discouraged due to the inherent process control limitations. In the event that a soldering iron must be employed the following precautions are recommended. Note :

- a) Preheat circuit and products to 150°C.
- b) 350°C tip temperature (Max.)
- c) Never contact the ceramic with the iron tip
- d) 1.0mm tip diameter (Max.)
- e) Use a 20 watt soldering iron with tip diameter of 1.0mm
- f) Limit soldering time to 4~5 sec.

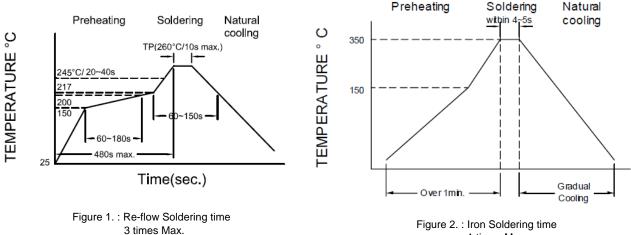


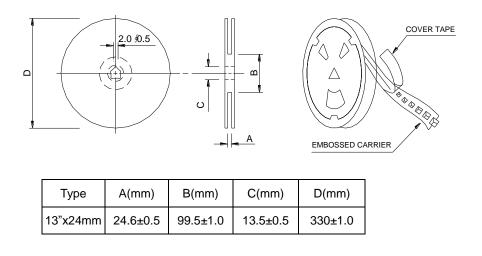
Figure 2. : Iron Soldering time 1 times Max.

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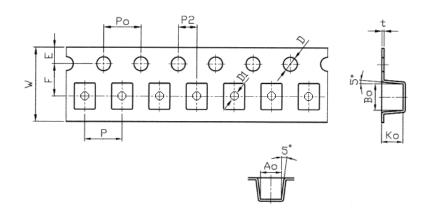
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## **10. Packaging Information:**

### **10-1 Reel Dimension**



### 10-2 Tape Dimension



Size	P(mm)	Po(mm)	P2(mm)	Bo(mm)	Ao(mm)	Ko(mm)
Size	12.00±0.10	4.00±0.10	2.00±0.10	9.40±0.10	5.50±0.10	3.90±0.10
WAEZ	D(mm)	D1(mm)	E(mm)	F(mm)	W(mm)	t(mm)
	1.50 +0.1/-0	1.50±0.10	1.75±0.10	11.5±0.10	24.0 +0.30/-0.1	0.35±0.05

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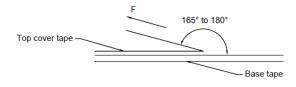
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#### **10-3 Packaging Quantity**

Chip Size	WAEZ	
Chip/Reel	1000	

#### **10-4 Tearing Off Force**



The force for tearing off cover tape is 10 to 130 grams in the arrow direction under the following conditions.

Room Temp. (°C)	Room Humidity (%)	Room atm (hPa)	Tearing Speed mm/min	
5~35	45~85	860~1060	300	

### **Application Notice:**

1. Storage Conditions:

To maintain the solderability of terminal electrodes:

- a) Recommended products should be used within 12 months from the time of delivery.
- b) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation:

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) Vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.

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